

## FBA Series

# Chip Ferrite Bead SMD Type Size 0805



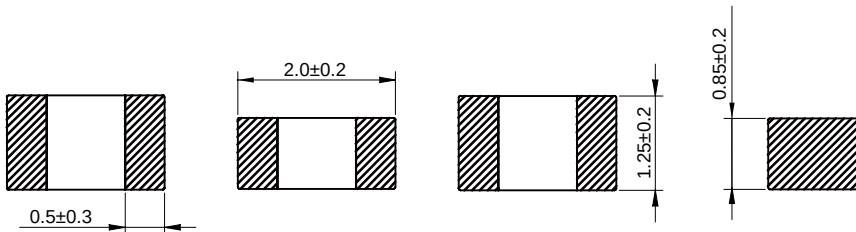
## FEATURES

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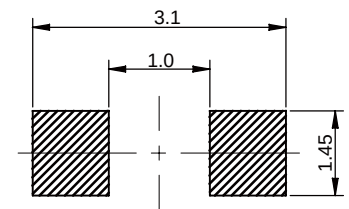
## APPLICATION

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Dimensions: [mm]



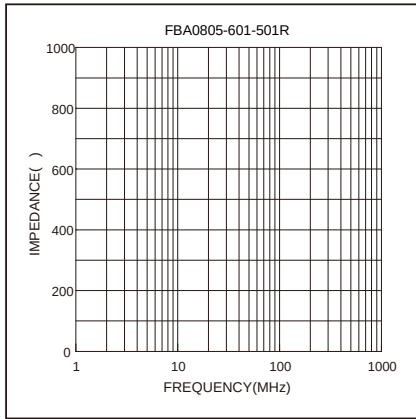
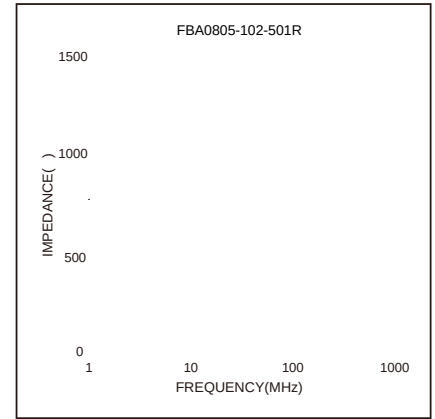
Land Pattern: [mm]



### Electrical Properties:

|   |                | Impedance<br>@ 100MHz<br>(Ω) | DC Resistance<br>Max.<br>(Ω) | Temperature<br>Rise Current<br>Max.<br>(mA) |
|---|----------------|------------------------------|------------------------------|---------------------------------------------|
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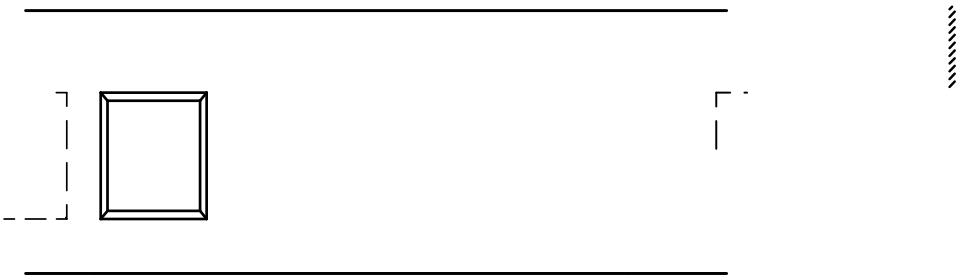
## Typical Electrical Characteristics:



# Soldering Reflow:

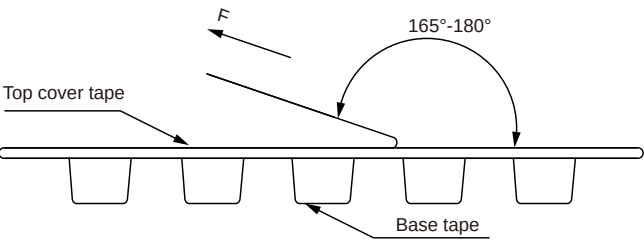
## Packaging Information:

Tape Dimension :



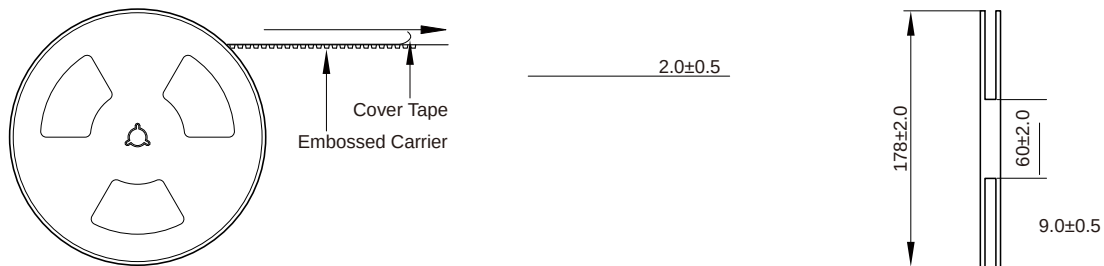
| Series | A0<br>(mm) | B0<br>(mm) | D<br>(mm) | P0<br>(mm) | P1<br>(mm) | W<br>(mm) | K0<br>(mm) | E<br>(mm) | T<br>(mm) |
|--------|------------|------------|-----------|------------|------------|-----------|------------|-----------|-----------|
| 0805   | 1.30±0.05  | 2.10±0.05  | 1.5±0.1   | 4.0±0.1    | 4.0±0.1    | 8.0±0.3   | 0.95±0.05  | 1.75±0.1  | 0.95±0.05 |

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.14 to 0.58 N

## Reel Dimension: [mm]



## Cautions and Warnings:

### Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

### Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.